# WINSTAR Display

# **OLED SPECIFICATION**

Model No:

## WEO012832FWPP3N00001

## SPECIFICATION Version: D





(FOR CUSTOMER USE ONLY)

SALES BY	APPROVED BY CHECKED BY	PREPARED BY
RELEASE DATE:		

APPROVAL FOR SPECIFICATIONS ONLY

**APPROVAL FOR SPECIFICATIONS AND SAMPLE** 

# **MODEL NO**:

REC	RECORDS OF REVISION		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2018/09/03		First release
A	2018/11/27		Modify Static electricity test Content of Test
В	2019/09/02		Modify Precautions in use of OLED Modules
C	2019/12/18		Modify Reliability Test and measurement conditions & Inspection specification:" Accept no dense" modify to "ignore"& Precautions
D	2020/08/27	V	Modify Inspection specification



# Contents

- 1.Module Classification Information
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- 11.Precautions in use of OLED Modules



# **1.Module Classification Information** $\underline{W}$ $\underline{E}$ $\underline{O}$ $\underline{012832}$ $\underline{F}$ $\underline{W}$ $\underline{P}$ $\underline{P}$ $\underline{3}$ $\underline{N}$ $\underline{0}$ $\underline{0$

1	Brand : WINSTAR DISPLAY CORPORATION						
2	E : OLED						
		H : COB Character	G : COB Graphic				
2	Dianlay Tyme	O : COG	F : COG + FR	XO			
3	Display Type	P : COG + FR + PCB	X : TAB				
		A : COG + PCB		Y			
4	Dot Matrix : 12	28 * 32					
5	Serials code		()				
		A : Amber	R : Red	C : Full Color			
6	Emitting Color	B : Blue	W : White				
0		G : Green	L : Yellow				
		S : Sky Blue	X : Dual Color				
7	Polarizer		P: With Polarizer; N: Without Polarizer				
		A : Anti-glare Polarize					
8	Display Mode						
9	Driver Voltage	3:3.0~3.3V;5:5					
10	Touch Panel	N: Without touch pane	ei; I: with touch panel				
		0 : Standard					
		1 : Daylight Readable					
11	Product type	2 : Transparent OLED	· /				
		3 : Flexible OLED (FO	LED)				
		4 : OLED Lighting 0 : Standard					
	Increation	2 : Special grade					
12	Inspection Grade	C : Automotive grade					
		Y : Consumer grade					
13	Option		PC ; H : Hot bar FPC; D :	Demo Kit			
14	Serial No.	Serial number(00~ZZ)					
14	Serial INU.						

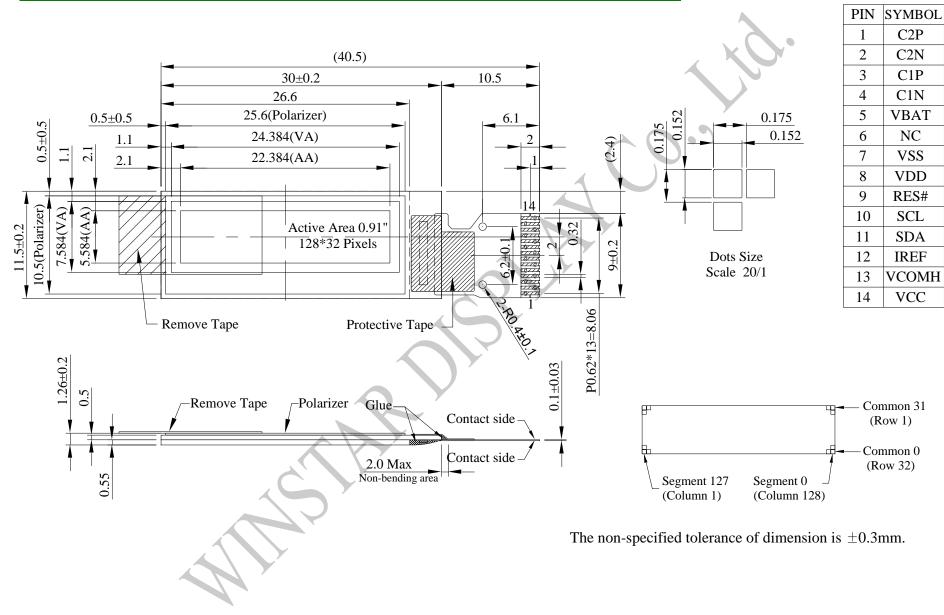
## **2.General Specification**

) **\*** \*

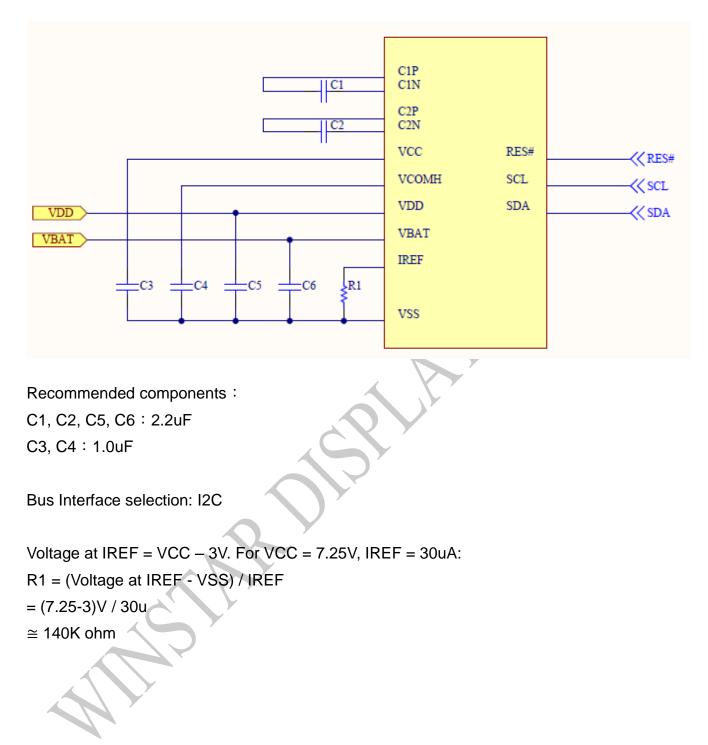
ltem	Dimension	Unit
Dot Matrix	128 × 32 Dots	-
Module dimension	30.0 × 11.5 × 1.26	mm
Active Area	22.384 × 5.584	mm
Pixel Size	0.152 × 0.152	mm
Pixel Pitch	0.175 × 0.175	mm
Display Mode	Passive Matrix	•
Display Color	White	
Drive Duty	1/32 Duty	
IC	SSD1306BZ	
Interface	I2C	
Size	0.91 inch	

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## **3. Contour Drawing & Block Diagram**



## **3.1 Application recommendations**



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# **4. Interface Pin Function**

No.	Symbol	Function
1	C2P	Desitive Terminal of the Chine Investige Consector Menetics Terminal of the
2	C2N	Positive Terminal of the Flying Inverting Capacitor Negative Terminal of the
3	C1P	<i>Flying Boost Capacitor</i> The charge-pump capacitors are required between the terminals. They must be floated when the converter is not used.
4	C1N	the terminals. They must be hoated when the converter is not used.
5	VBAT	Power Supply for DC/DC Converter Circuit This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to external source when the converter is used. It should be connected to VDD when the converter is not used.
6	NC	No connection
7	VSS	Ground of Logic Circuit This is a ground pin. It acts as a reference for the logic pins. It must be connected to external ground.
8	VDD	Power Supply for Logic This is a voltage supply pin. It must be connected to external source.
9	RES#	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.
10	SCL	I2C mode is selected, D2, D1 should be tied together and serve as SDAout,
11	SDA	SDAin in application and D0 is the serial clock input, SCL.
12	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5µA.
13	VCOMH	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
14		Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.

## **5.Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	0	4.0	V	1,2
Supply Voltage for Display	VCC	0	16.0	V	1,2
Operating Temperature	TOP	-40	+80	°C	<i>C</i> .
Storage Temperature	TSTG	-40	+85	°C	

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

## **6.Electrical Characteristics**

## **6.1 DC Electrical Characteristics**

ltem	Symbol	Condition	Min	Тур	Мах	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	—	7	7.25	8	V
Input High Volt.	VIH	—	0.8×VDD		VDDIO	V
Input Low Volt.	VIL	—	0		0.2×VDD	V
Output High Volt.	VOH	—	0.9×VDD		VDDIO	V
Output Low Volt.	VOL	-	0	_	0.1×VDD	V
Operating Current for VCC (VCC Supplied Externally)	ICC	Vcc =7.25V	<b>S</b> –	7	11	mA

## 6.2 Initial code

void Initial\_ic(void){

Write\_command(0xAE); // Display Off

Write\_command(0xD5); //SET DISPLAY CLOCK Write\_command(0x80); //105HZ

Write\_command(0xA8); // Select Multiplex Ratio Write\_command(0x1F); // Default => 0x3F (1/64 Duty)

Write\_command(0xD3); //Setting Display Offset Write\_command(0x00); //00H Reset

Write\_command(0x40); //Set Display Start Line

Write\_command(0x8D); // Set Charge Pump Write\_command(0x14); // Endable Charge Pump

Write\_command(0xA1); //Set Segment Re-Map Default

Write\_command(0xC8); //Set COM Output Scan Direction

Write\_command(0xDA); //Set COM Hardware Configuration Write\_command(0x02); //Alternative COM Pin---See IC Spec page 34

Write\_command(0x81); //Set Contrast Control Write\_command(0x8F);

Write\_command(0xD9); //Set Pre-Charge period Write\_command(0x22);

Write\_command(0xDB); //Set Deselect Vcomh level Write\_command(0x40);

Write\_command(0xA4); //Entire Display ON

Write\_command(0xA6); //Set Normal Display

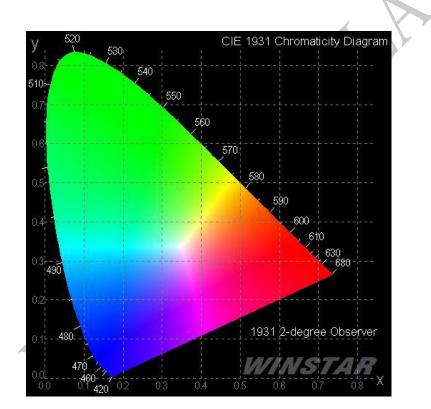
Write\_command(0xAF); // Display ON

}

0x1F(1/32 Duty)

# **7.Optical Characteristics**

ltem	Symbol	Condition	Min	Тур	Мах	Unit
	(V)θ	_	160	_		deg
View Angle	(H)φ		160	_	_	deg
Contrast Ratio	CR	Dark	2000:1	_		-
Deer en ee Time	T rise		_	10		μs
Response Time	T fall		_	10		μs
Display with Full Pixel on	Brightness		100	120	• <b>`</b> _	cd/m2
CIEx(White)		(CIE1931)	0.26	0.28	0.30	_
CIEy(White)		(CIE1931)	0.30	0.32	0.34	



## 8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness 100cd/m <sup>2</sup>	20,000 Hrs	_	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.

# 9.Reliability

#### **Content of Reliability Test**

Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	$-\langle \rangle$
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min	-40°C /80°C 30 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	
Others		I	
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	

\*\*\* Supply voltage for OLED system =Operating voltage at 25°C

#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### **Evaluation criteria**

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### **RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

## **10.Inspection specification**

## **Inspection Standard:**

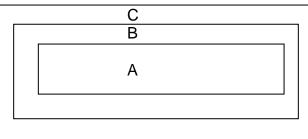
MIL-STD-105E table normal inspection single sample level II.

## Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer`s product.

## **Inspection Methods**

- 1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.
- 2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	ltem	Criterion	AQL
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 OLED viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ol>	0.65
02	Black or white spots on OLED (display only)	<ul> <li>2.1 White and black spots on display ≤ 0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm.</li> </ul>	2.5

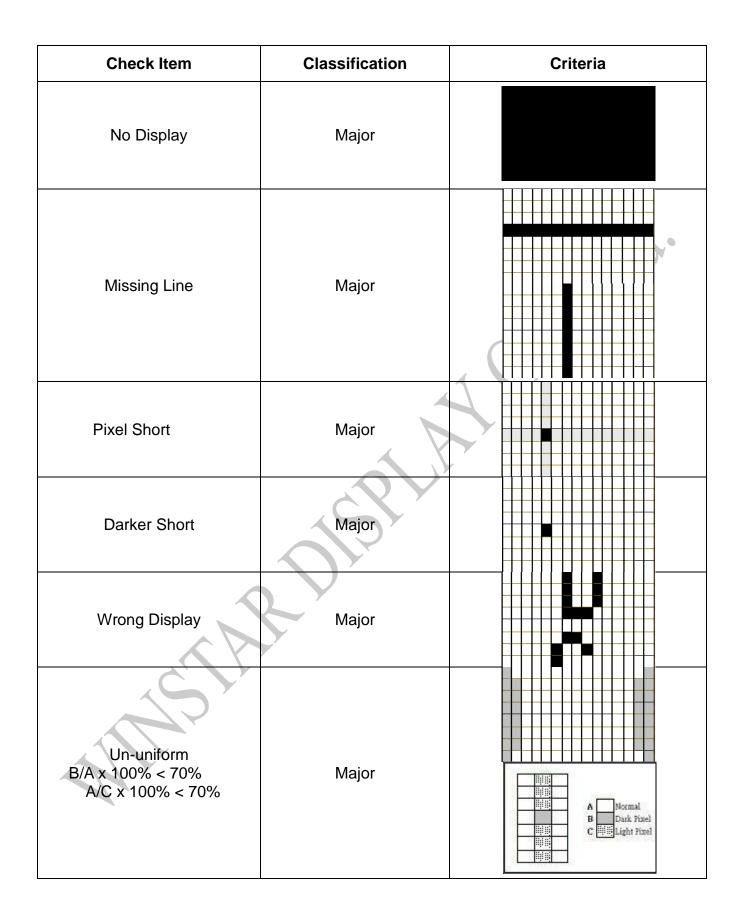
NO	Item		Criterio	า		AQL
	OLED black spots, white spots, contaminati on (non- display)	3.1 Round type : As following drawing $\Phi=(x + y) / 2$	SIZE Φ≦0.10 0.10<Φ≦0.20 0.20<Φ≦0.25 0.25<Φ	Acceptable QTY ignore 2 1 0	Zone A+ B A+ B A+ B A+ B	2.5
03		3.2 Line type : (As	n Width W≦0.02 0 0.02 <w≦0.0< td=""><td>Acceptable Q TY ignore</td><td>Zone A+B A+B A+B</td><td>2.5</td></w≦0.0<>	Acceptable Q TY ignore	Zone A+B A+B A+B	2.5
04	Polarizer bubbles /Dent	<ul> <li>4.1 If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.</li> <li>4.2 The polarizer of</li> </ul>	Size $\Phi$ $\Phi \leq 0.20$ $0.20 < \Phi \leq 0.50$ $0.50 < \Phi \leq 1.00$ $1.00 < \Phi$ Total Q TY dent follows this sp	Acceptable Q TY ignore 3 2 0 3 ecification.	Zone A+B A+B A+B A+B	2.5
05	Scratches	Follow NO.3 OLE	D black spots, whit	e spots, contamina	tion.	

NO	Item	Criterion	AQL
06	Chipped glass	Symbols Define: x: Chip length t: Glass thickness k: Seal width 	2.5
06	Glass crack	$\begin{array}{c} \text{Symbols :} \\ \text{x: Chip length} & \text{y: Chip width} & \text{z: Chip thickness} \\ \text{k: Seal width} & \text{t: Glass thickness} & \text{a: OLED side length} \\ \text{L: Electrode pad length} \\ \text{6.2 Protrusion over terminal :} \\ \text{6.2.1 Chip on electrode pad :} \\ \hline \\ $	2.5

NO	Item	Criterion	AQL		
		6.2.2 Non-conductive portion:			
06	Glass crack	y z z y z z z x			
		y: Chip width x: Chip length z: Chip thickness			
		y≤ L       x≤1/8a       0 < z ≤ t	2.5		
		$y: width \qquad x: length \\ y \leq 1/3L \qquad x \leq a$			
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5		
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.</li> </ul>	0.65 2.5		
		8.3 Backlight doesn't light or color wrong.	0.65		
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65		
10	PCB, COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height</li> </ul>	2.5 2.5 0.65		
		<ul> <li>indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> </ul>	2.5		
		<ul> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> </ul>	2.5 0.65		
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65		
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5		
▶▶▶ \\//\\ICTAD WEO012832EW/PP3N00001					

NO	Item	Criterion	AQL
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65
12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 OLED pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

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## **11.Precautions in use of OLED Modules**

## Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Winstar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) Winstar has the right to upgrade or modify the product function.

#### 11.1. Handling Precautions

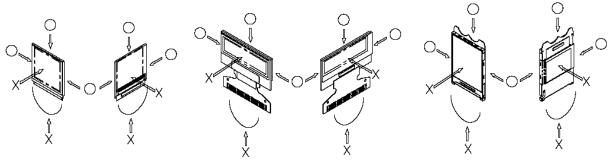
- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the TCP & FPC
- (8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the

display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OLED display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.

\* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

\* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

#### 11.2. Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. (We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

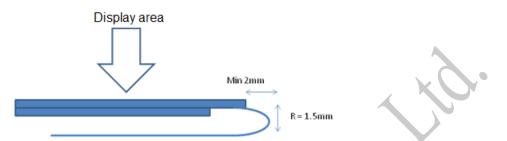
#### 11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

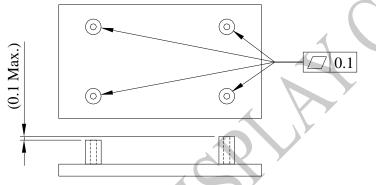
\* Connection (contact) to any other potential than the above may lead to rupture of the IC.

- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.

- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



(13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

#### 11.4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.